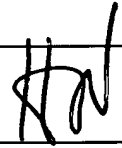
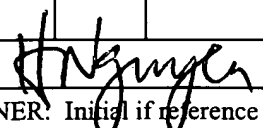


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| U.S. Department of Commerce, Patent and Trademark Office | | | | Atty Docket No. | | Serial No. | |
| | | | | M-9749 US | | 09/768,528 | |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary) | | | | Applicant(s) | | | |
| | | | | Chin-Tau Lea | | | |
| | | | | Filing Date | | Group | |
| | | | | January 23, 2001 | | Unknown | |
| U.S. Patent Documents | | | | | | | |
| *Examiner Initial | | Document Number | Date | Name | Class | Subclass | Filing Date If Appropriate |
| | AA | | | | | | |
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| Foreign Patent Documents | | | | | | | |
| | | | | | | | Translation |
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| | AL | | | | | | |
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| OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.) | | | | | | | |
|  | AQ | PM9311/2/3/5, Enhanced TT1 Chip Set, Enhanced TT1 Switch Fabric Datasheet; Issue 2: August 2000; PMC-Sierra, Inc. pp. i-306 | | | | | |
| | AR | | | | | | |
| | AS | | | | | | |
| Examiner |  | | Date Considered 6/9/04 | | | | |
| *EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant. | | | | | | | |